SPECIFICATION
FOR
APPROVAL

( ) **Preliminary Specification**
(◆) **Final Specification**

Title	14.1”W WXGA+ TFT LCD

Customer	Dell
MODEL	

SUPPLIER	LG Display Co., Ltd.
*MODEL	LP141WP2
Suffix	TPA1

*When you obtain standard approval,
please use the above model name without suffix

APPROVED BY	SIGNATURE
/	
/	
/	

Please return 1 copy for your confirmation with your signature and comments.

APPROVED BY	SIGNATURE
H. S. Kim / S.Manager	
REVIEWED BY	
C. I. Kim / Manager	
PREPARED BY	
C. H. Cho / Engineer C. Y. Jung / Engineer	

Products Engineering Dept.
LG Display Co., Ltd

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RECORD OF REVISIONS

Revision No	Revision Date	Page	Description	EDID ver
0.0	Jul. 31, 2009	-	First Draft (Preliminary Specification)	0.0
0.1	Nov. 2nd, 2009	6-7	Electrical Characteristics	
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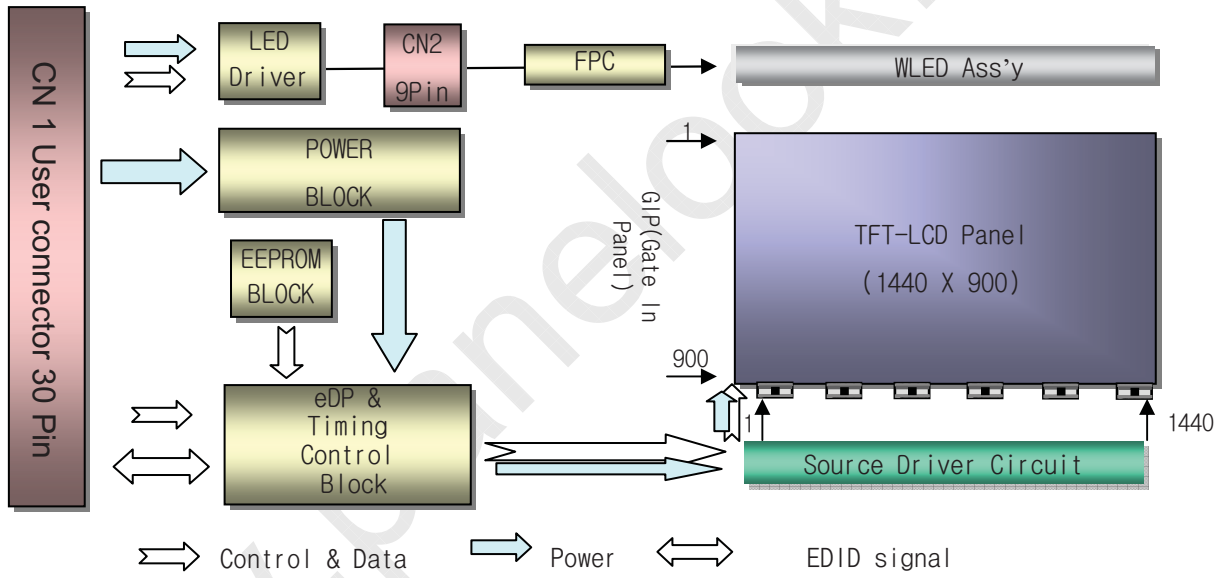
		31-33	EDID	
1.0	Mar. 5, 2010		Final Draft (update EDID)	1.0

1. General Description

The LP141WP2 is a Color Active Matrix Liquid Crystal Display with an integral LED backlight system. The matrix employs a-Si Thin Film Transistor as the active element. It is a transmissive type display operating in the normally white mode. This TFT-LCD has 14.1 inches diagonally measured active display area with WXGA+ resolution(1440 horizontal by 900 vertical pixel array). Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 6-bit gray scale signal for each dot, thus, presenting a palette of more than 262,144 colors.

The LP141WP2 has been designed to apply the interface method that enables low power, high speed, low EMI.

The LP141WP2 is intended to support applications where thin thickness, low power are critical factors and graphic displays are important. In combination with the vertical arrangement of the sub-pixels, the LP141WP2 characteristics provide an excellent flat display for office automation products such as Notebook PC.



General Features

Active Screen Size	14.1 inches diagonal
Outline Dimension	319.5 (H) × 206.5 (V) × 5.5(D, max.) mm
Pixel Pitch	0.2106 mm × 0.2106 mm
Pixel Format	1440 horiz. by 900 vert. Pixels RGB strip arrangement
Color Depth	6-bit, 262,144 colors
Luminance, White	300 cd/m^2(Typ., @I_{LED}=18mA) , 5 points Average
Power Consumption	Total 5.22Watt @ LCM circuit 1.5W(Typ.), LED 3.72W(Typ.)
Weight	375g(Max.)
Display Operating Mode	Transmissive mode, normally white
Surface Treatment	Anti Glare treatment of the front polarizer
RoHS Comply	Yes
BFR / PVC / As Free	Yes all.

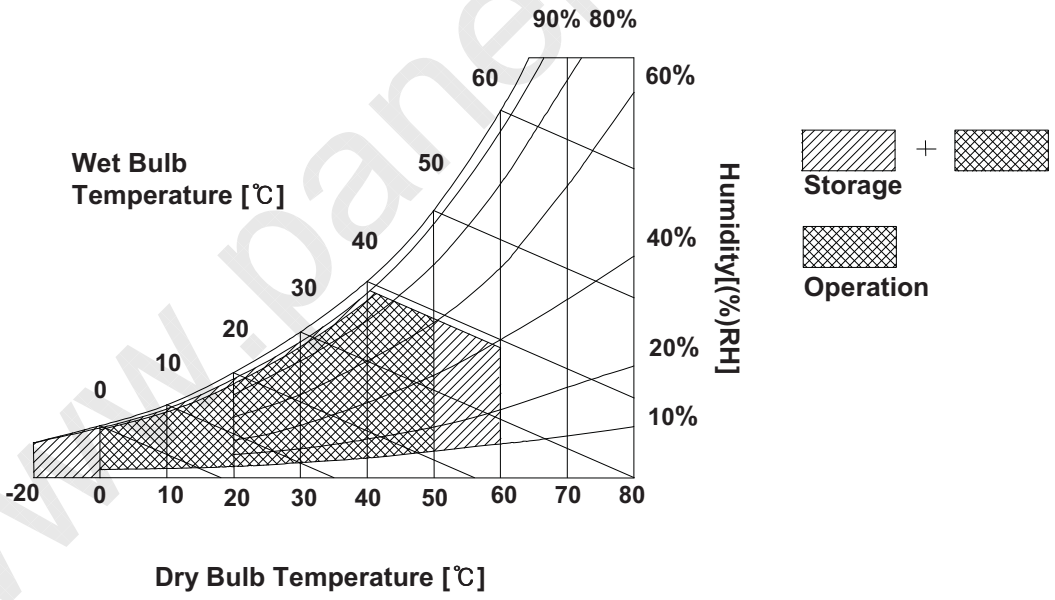
2. Absolute Maximum Ratings

The following are maximum values which, if exceeded, may cause faulty operation or damage to the unit.

Table 1. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Values		Units	Notes
		Min	Max		
Power Input Voltage	VCC	-0.3	4.0	Vdc	at 25 ± 5°C
Operating Temperature	TOP	0	50	°C	1
Storage Temperature	HST	-20	60	°C	1
Operating Ambient Humidity	HOP	10	90	%RH	1
Storage Humidity	HST	10	90	%RH	1

Note : 1. Temperature and relative humidity range are shown in the figure below.
Wet bulb temperature should be 39°C Max, and no condensation of water.



3. Electrical Specifications

3-1. Electrical Characteristics

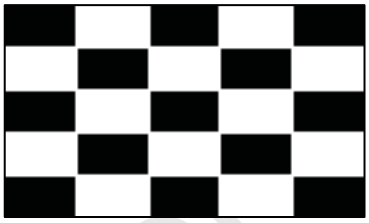
The LP141WP2 requires two power inputs. The first logic is employed to power the LCD electronics and to drive the TFT array and liquid crystal. The second backlight is the input about LED B/L with LED Driver.

Table 2. ELECTRICAL CHARACTERISTICS

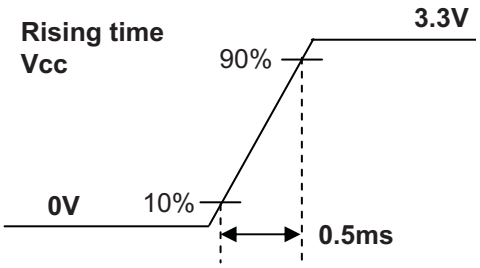
Parameter	Symbol	Values			Unit	Notes
		Min	Typ	Max		
LOGIC :						
Power Supply Input Voltage	V_{CC}	3.0	3.3	3.6	V	1
Power Supply Input Current Mosaic	I_{CC}	-	450	520	mA	2
Power Consumption	P_{CC}	-	1.5	1.72	W	2
Power Supply Inrush Current	I_{CC_P}	-	700	1000	mA	3
LVDS Impedance	Z_{LVDS}	90	100	110	Ω	4
BACKLIGHT : (with LED Driver)						
LED Power Input Voltage	V_{LED}	7.0	12.0	21.0	V	5
LED Power Input Current	I_{LED}	-	310	330	mA	6
LED Power Consumption	P_{LED}	-	3.72	3.96	W	6
LED Power Inrush Current	I_{LED_P}	-	700	900	mA	7
PWM Duty Ratio	-	5	-	100	%	8
PWM Jitter	-	0	-	0.2	%	9
PWM Impedance	Z_{PWM}	20	40	60	kΩ	
PWM Frequency	F_{PWM}	9.5	10	10.5	kHz	10
PWM High Level Voltage	V_{PWM_H}	3.0	-	5.3	V	
PWM Low Level Voltage	V_{PWM_L}	0	-	0.3	V	
LED_EN Impedance	Z_{PWM}	20	40	60	kΩ	
LED_EN High Voltage	$V_{LED\_EN\_H}$	3.0	-	5.3	V	
LED_EN Low Voltage	$V_{LED\_EN\_L}$	0	-	0.3	V	
SMBus CLK & Data High Level Voltage	V_{SBL_H}	3.0	-	5.3	V	
SMBus CLK & Data Low Level Voltage	V_{SBL_L}	0	-	0.3	V	
SMBus CLK Frequency	F_{SB_C}	50	55	60	kHz	
SMBus Data Setup time	T_{SBD_S}	250	-	-	us	
SMBus Data Hold time	T_{SBD_H}	300	-	-	us	
SMBus CLK/Data Rising time	T_{SB_R}	-	-	3	us	
SMBus CLK/Data Falling time	T_{SB_F}	-	-	3	us	
Life Time	-	10,000	-	-	Hrs	11

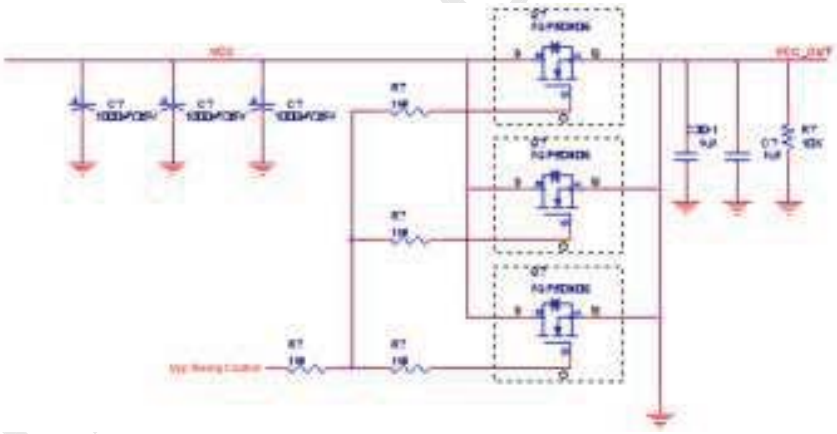
Note)

1. The measuring position is the connector of LCM and the test conditions are under 25℃, fv = 60Hz, Black pattern.
2. The specified Icc current and power consumption are under the Vcc = 3.3V , 25℃, fv = 60Hz condition and **Mosaic** pattern.

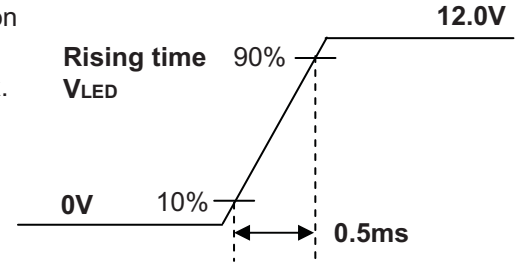


3. The below figures are the measuring Vcc condition and the Vcc control block LGD used. The Vcc condition is same as the minimum of T1 at Power on sequence.





4. This impedance value is needed for proper display and measured form LVDS Tx to the mating connector.
5. The measuring position is the connector of LCM and the test conditions are under 25℃.
6. The current and power consumption with LED Driver are under the Vled = 12.0V , 25℃, Dimming of Max luminance and White pattern with the normal frame frequency operated(60Hz).
7. The below figures are the measuring Vled condition and the Vled control block LGD used. VLED control block is same with Vcc control block.

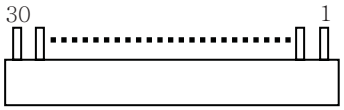


8. The operation of LED Driver below minimum dimming ratio may cause flickering or reliability issue.
9. If Jitter of PWM is bigger than maximum, it may induce flickering.
10. This Spec. is not effective at 100% dimming ratio as an exception because it has DC level equivalent to 0Hz. In spite of acceptable range as defined, the PWM Frequency should be fixed and stable for more consistent brightness control at any specific level desired.
11. The life time is determined as the time at which brightness of LCD is 50% compare to that of minimum value specified in table 7. under general user condition.

3-2. Interface Connections

This LCD employs two interface connections, a 30 pin connector is used for the module electronics interface and the other connector is used for the integral backlight system.
The electronics interface connector is a model KN38-30S-0.5H manufactured by Hirose.

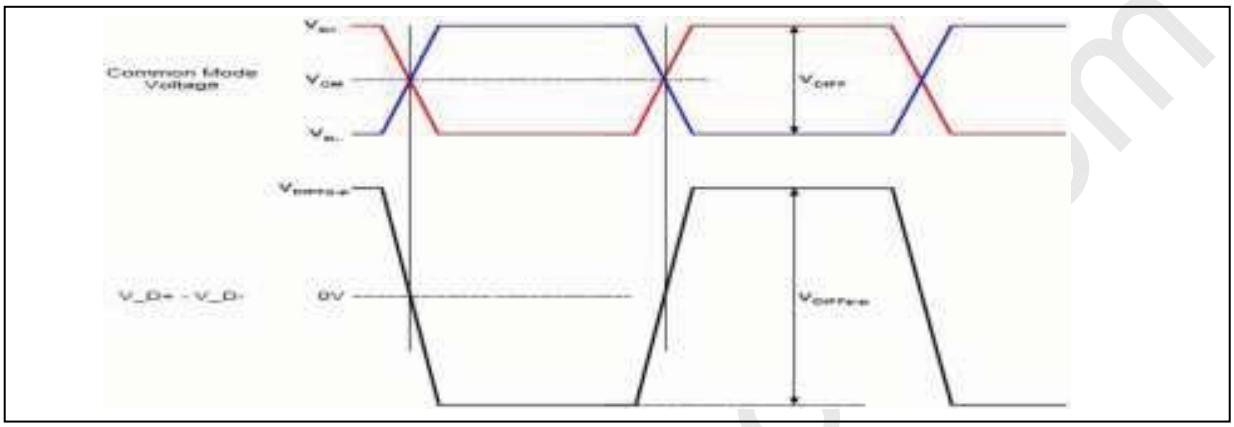
Table 3. MODULE CONNECTOR PIN CONFIGURATION (CN1)

Pin	Symbol	Description	Notes
1	Test loop	Dell test loop to pin 30	1, Interface chips 1.1 LCD : IDT, VPP1420 (LCD Controller) including eDP Receiver 1.2 System : GM60028 or ANX9804 or equivalent * Pin to Pin compatible with eDP 2. Connector 2.1 LCD : KN38-30S-0.5H, Hirose or its compatibles 2.2 Mating : 20345-#30E-## series or equivalent 2.3 Connector pin arrangement  [LCD Module Rear View]
2	GND	LCM Ground	
3	NC	No Connection	
4	NC	No Connection	
5	GND	LCM Ground	
6	ML0-	Complement Signal-Lane 0	
7	ML0+	True Signal-Main Lane 0	
8	GND	LCM Ground	
9	AUX+	True Signal-Auxiliary Channel	
10	AUX-	Complement Signal-Auxiliary Channel	
11	GND	LCM Ground	
12	VCC	VCC for Module (3.3V)	
13	VCC	VCC for Module (3.3V)	
14	BIST	Built-In Self Test (active high)	
15	GND	LCM Ground	
16	GND	LCM Ground	
17	HPD	HPD signal pin	
18	BL_GND	LCM Ground (LED Backlight Ground)	
19	BL_GND	LCM Ground (LED Backlight Ground)	
20	BL_GND	LCM Ground (LED Backlight Ground)	
21	BL_GND	LCM Ground (LED Backlight Ground)	
22	LED_EN	LED Backlight On/Off	
23	PWM	System PWM Signal input for dimming	
24	SMB_CLK	SMBus Clock	
25	SMB_Data	SMBus Data	
26	VBL	BL Power 7V-20V	
27	VBL	BL Power 7V-20V	
28	VBL	BL Power 7V-20V	
29	VBL	BL Power 7V-20V	
30	Test loop	Dell test loop to pin 1	

3-3. eDP Signal Timing Specifications

3-3-1. DC Specification

The VESA Display Port related AC specification is compliant with the VESA Display Port Standard v1.1a.



Description	Symbol	Min	Max	Unit	Notes
Differential peak-to-peak Input voltage	VDIFF p-p	120	-	mV	For high bit rate
		40	-		For reduced bit rate
Rx DC common mode voltage	VCM	0	2.0	V	-

3-3-2. AC Specification

The VESA Display Port related AC specification is compliant with the VESA Display Port Standard v1.1a.

Description	Symbol	Min	Typ	Max	Unit	Notes
Unit Interval for high bit rate (2.7Gbps/lane)	UI_High_Rate	-	370	-	ps	Range is nominal ±350ppm. DisplayPort Link Rx does not require local crystal for link clock generation
Unit Interval for high bit rate (1.62Gbps/lane)	UI_Low_Rate	-	617	-	ps	
Lane-to-Lane skew	V Rx-SKEW-INTER_PAIR	-	-	5200	ps	-
Lane intra-pair skew	V Rx-SKEW-INTRA_PAIR	-	-	100	ps	For high bit rate
		-	-	300	ps	For reduced bit rate

3-4. Signal Timing Specifications

This is the signal timing required at the input of the User connector. All of the interface signal timing should be satisfied with the following specifications and specifications of LVDS Tx/Rx for its proper operation.

Table 5. TIMING TABLE (The Standard of 60Hz Refresh Rate)

ITEM	Symbol		Min	Typ	Max	Unit	Note
DCLK	Frequency	f_{CLK}	-	85.4	-	MHz	1port
Hsync	Period	t_{HP}	1528	1552	1576	f_{CLK}	1port
	Blanking Total	$t_{HFP} + t_{WH} + t_{HBP}$	88	112	136		
	Width-Active	t_{WHA}	1440	1440	1440		
Vsync	Period	t_{VP}	913	917	920	t_{HP}	
	Blanking Total	$t_{VFP} + t_{WV} + t_{VBP}$	13	17	20		
	Width-Active	t_{WVA}	900	900	900		

Note1) Tentative Timing Table for 50Hz Refresh Rate

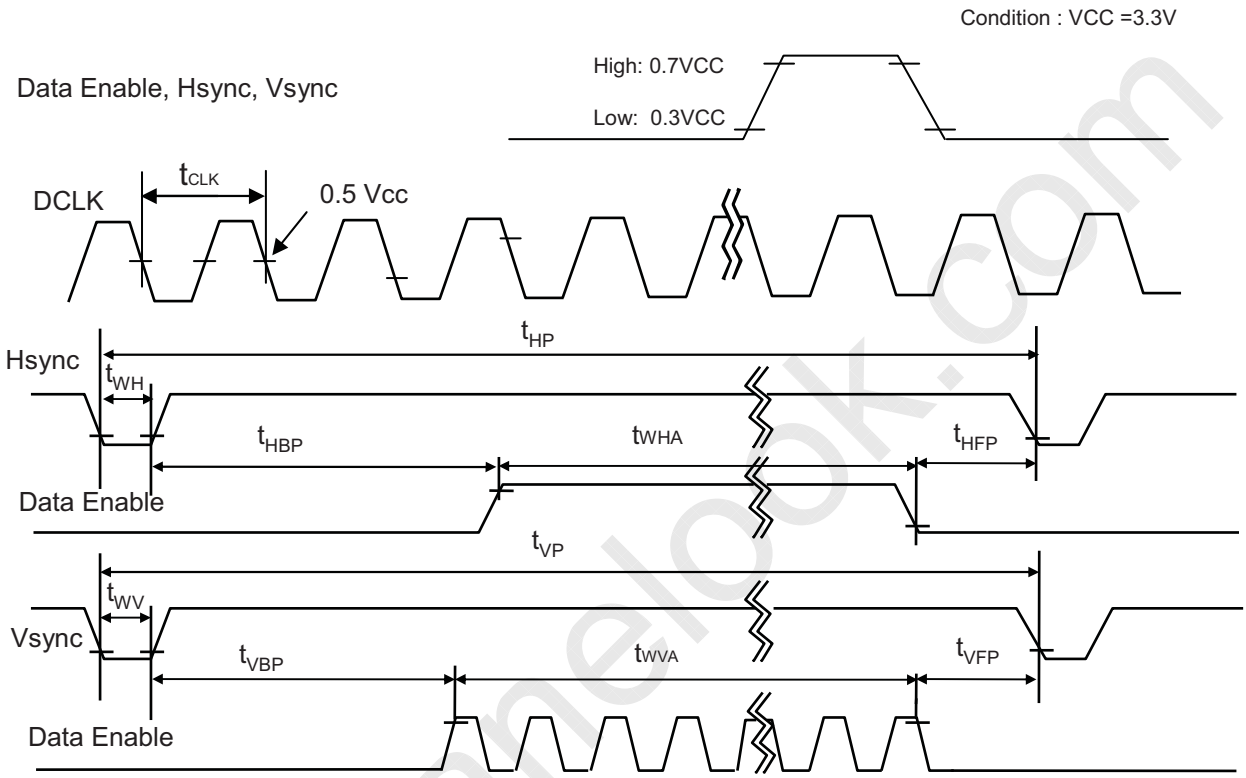
ITEM	Symbol		Min	Typ	Max	Unit	Note
DCLK	Frequency	f_{CLK}	-	-	-	MHz	1port
Hsync	Period	t_{HP}	-	-	-	f_{CLK}	1port
	Blanking Total	$t_{HFP} + t_{WH} + t_{HBP}$	-	-	-		
	Width-Active	t_{WHA}	-	-	-		
Vsync	Period	t_{VP}	-	-	-	t_{HP}	
	Blanking Total	$t_{VFP} + t_{WV} + t_{VBP}$	-	-	-		
	Width-Active	t_{WVA}	-	-	-		

Note 2) Tentative Timing Table for 40Hz Refresh Rate

ITEM	Symbol		Min	Typ	Max	Unit	Note
DCLK	Frequency	f_{CLK}	-	60	-	MHz	1port
Hsync	Period	t_{HP}	1608	1632	1664	f_{CLK}	1port
	Blanking Total	$t_{HFP} + t_{WH} + t_{HBP}$	128	192	224		
	Width-Active	t_{WHA}	1440	1440	1440		
Vsync	Period	t_{VP}	910	920	948	t_{HP}	
	Blanking Total	$t_{VFP} + t_{WV} + t_{VBP}$	10	20	48		
	Width-Active	t_{WVA}	900	900	900		

Note 3) This model don't guarantee the image quality about flicker level and gate block/line dim at power saving mode with 50Hz or 40 Hz Refresh rate.

3-5. Signal Timing Waveforms



3-6. Color Input Data Reference

The brightness of each primary color (red,green and blue) is based on the 6-bit gray scale data input for the color ; the higher the binary input, the brighter the color. The table below provides a reference for color versus data input.

Table 5. COLOR DATA REFERENCE

Color		Input Color Data																	
		RED						GREEN						BLUE					
		MSB					LSB	MSB					LSB	MSB					LSB
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
Basic Color	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RED	RED (00)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (01)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	...			...						...						...			
	RED (62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
GREEN	GREEN (00)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN (01)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	...			...						...						...			
	GREEN (62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	GREEN (63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
BLUE	BLUE (00)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE (01)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	...			...						...						...			
	BLUE (62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	BLUE (63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

3-7. Power Sequence

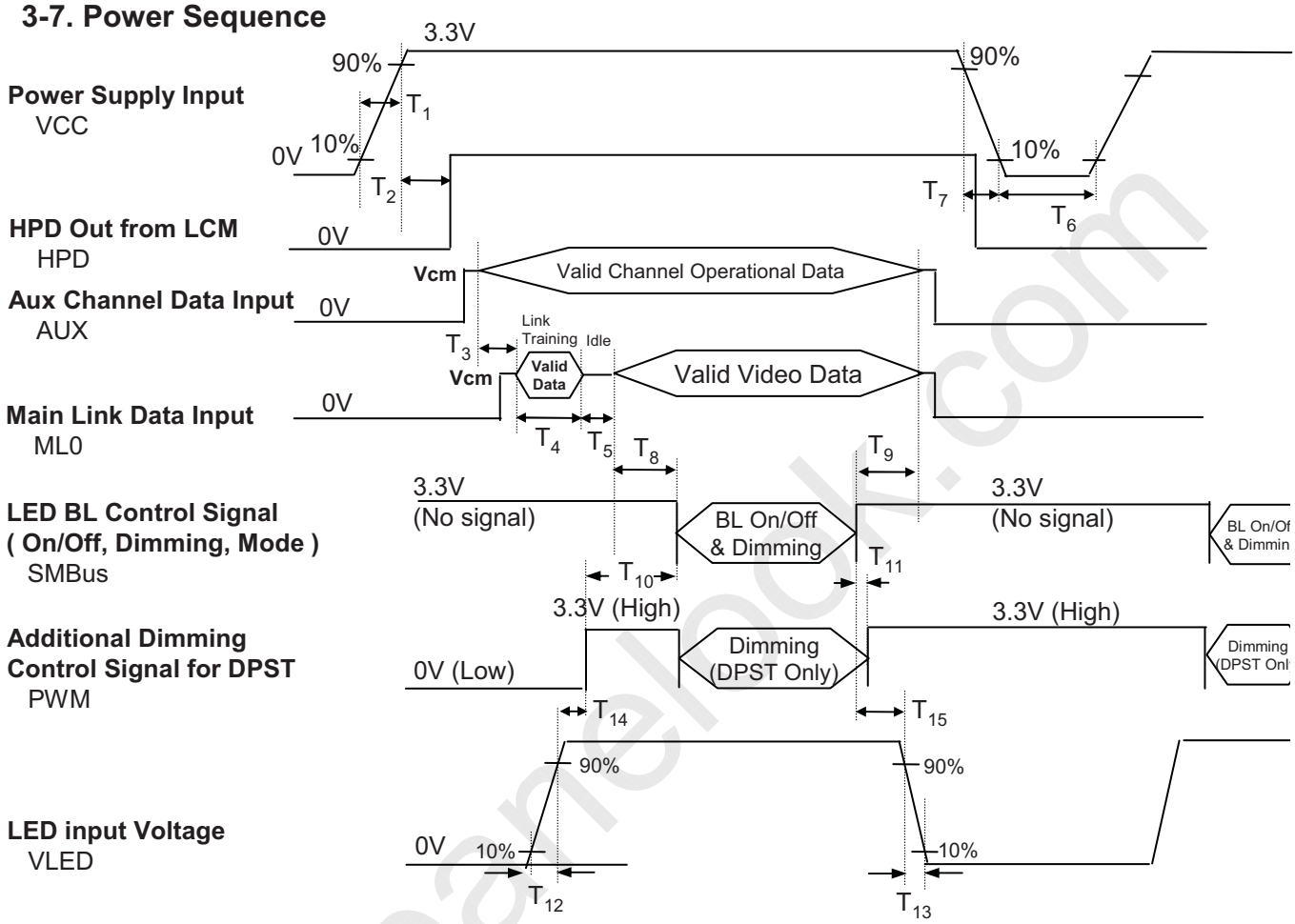


Table 6. POWER SEQUENCE TABLE

Logic Parameter	Value			Units	LED Parameter	Value			Units
	Min.	Typ.	Max.			Min.	Typ.	Max.	
T_1	0.5	-	10	ms	T_9	200	-	-	ms
T_2	0	-	200	ms	T_{10}	200	-	-	ms
T_3	50	75	-	ms	T_{11}	0	-	50	ms
T_4	0	-	-	ms	T_{12}	0.5	-	-	ms
T_5	0	-	-	ms	T_{13}	0	-	5000	ms
T_6	500	-	-	ms	T_{14}	0	-	-	ms
T_7	3	-	10	ms	T_{15}	50	-	-	ms
T_8	200	-	-	ms					

Note)
1. Do not insert the mating cable when system turn on.
2. Valid Data have to meet "3-3. eDP Signal Timing Specifications"
3. LVDS, LED_EN and PWM need to be on pull-down condition on invalid status.
4. LGD recommend the rising sequence of VLED after the Vcc and valid status of LVDS turn on.

4. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25°C. The values specified are at an approximate distance 50cm from the LCD surface at a viewing angle of Φ and Θ equal to 0°.
FIG. 1 presents additional information concerning the measurement equipment and method.

FIG. 1 Optical Characteristic Measurement Equipment and Method

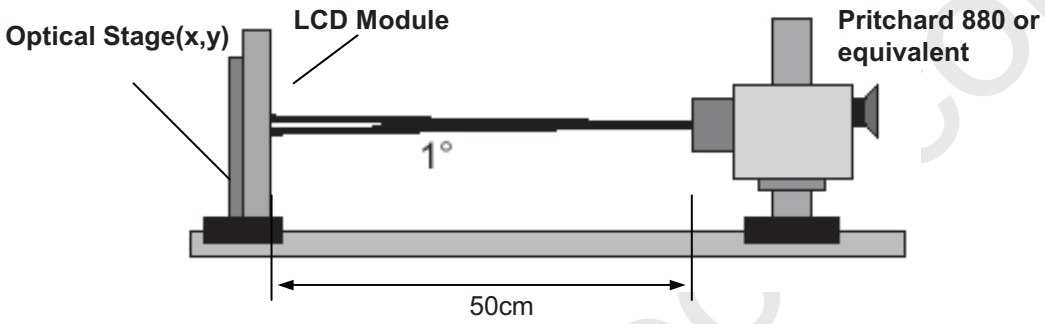


Table 7. OPTICAL CHARACTERISTICS

Ta=25°C, VCC=3.3V, fv=60Hz, f_{CLK}= 86.5MHz

Parameter	Symbol	Values			Units	Notes
		Min	Typ	Max		
Contrast Ratio	CR	-	350	-		1
Surface Luminance, white	L_{WH}	250	300	-	cd/m²	2
Luminance Variation(13points)	δ_{WHITE}		1.4	1.6		3
Response Time	Tr_R+ Tr_D		16	25	ms	4
Color Coordinates						
RED	RX	0.547	0.577	0.607		
	RY	0.319	0.349	0.379		
GREEN	GX	0.299	0.329	0.359		
	GY	0.520	0.550	0.580		
BLUE	BX	0.132	0.162	0.192		
	BY	0.103	0.133	0.163		
WHITE	WX	0.283	0.313	0.343		+/- 0.030
	WY	0.299	0.329	0.359		+/- 0.030
Viewing Angle						5
x axis, right(Φ=0°)	Θr	40	45	-	degree	
x axis, left (Φ=180°)	Θl	40	45	-	degree	
y axis, up (Φ=90°)	Θu	10	15	-	degree	
y axis, down (Φ=270°)	Θd	30	35	-	degree	
Gray Scale		-	-	-		6

Note)

1. Contrast Ratio(CR) is defined mathematically as

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

2. Surface luminance is the average of 5 point across the LCD surface 50cm from the surface with all pixels displaying white. For more information see FIG 1.

$$L_{WH} = \text{Average}(L_1, L_2, \ldots L_5)$$

3. The variation in surface luminance , The panel total variation (δ_{WHITE}) is determined by measuring L_N at each test position 1 through 13 and then defined as followed numerical formula. For more information see FIG 2.

$$\delta_{WHITE} = \frac{\text{Maximum}(L_1, L_2, \ldots L_{13})}{\text{Minimum}(L_1, L_2, \ldots L_{13})}$$

4. Response time is the time required for the display to transition from white to black (rise time, Tr_R) and from black to white(Decay Time, Tr_D). For additional information see FIG 3.

5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 4.

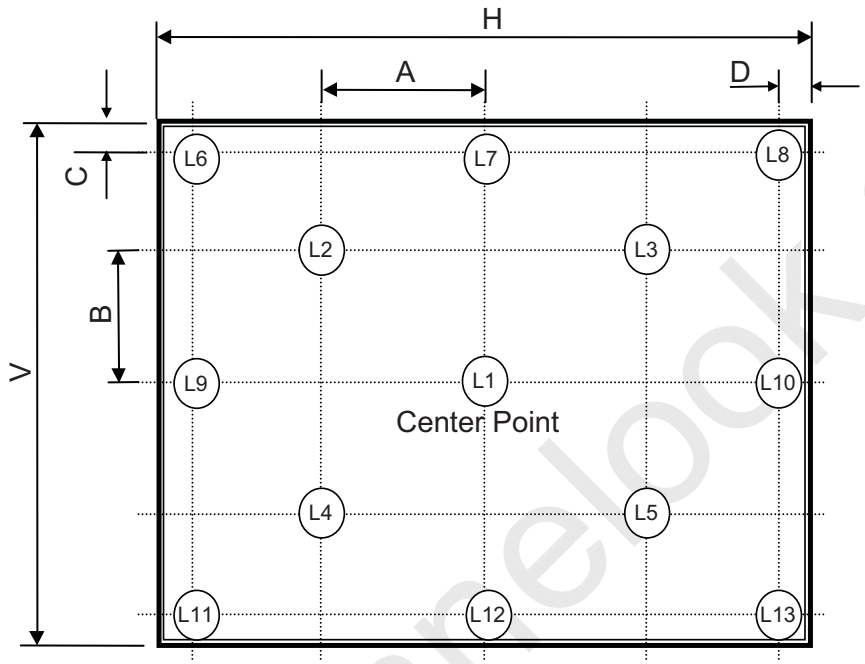
6. Gray scale specification

* f_V = 60Hz

Gray Level	Luminance [%] (Typ)
L0	0.33
L7	1.47
L15	4.5
L23	10.7
L31	19.9
L39	33.0
L47	50.8
L55	73.0
L63	100

FIG. 2 Luminance

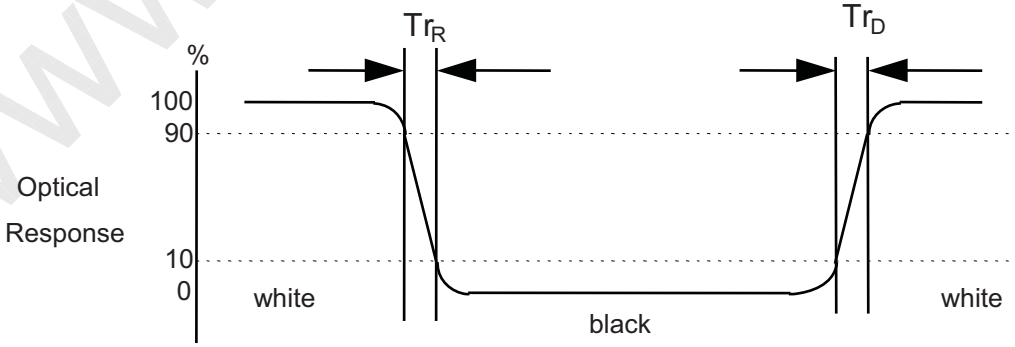
<measuring point for surface luminance & measuring point for luminance variation>



H,V : ACTIVE AREA
A : H/4 mm
B : V/4 mm
C : 10 mm
D : 10 mm
POINTS : 13 POINTS

FIG. 3 Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for “black” and “white”.



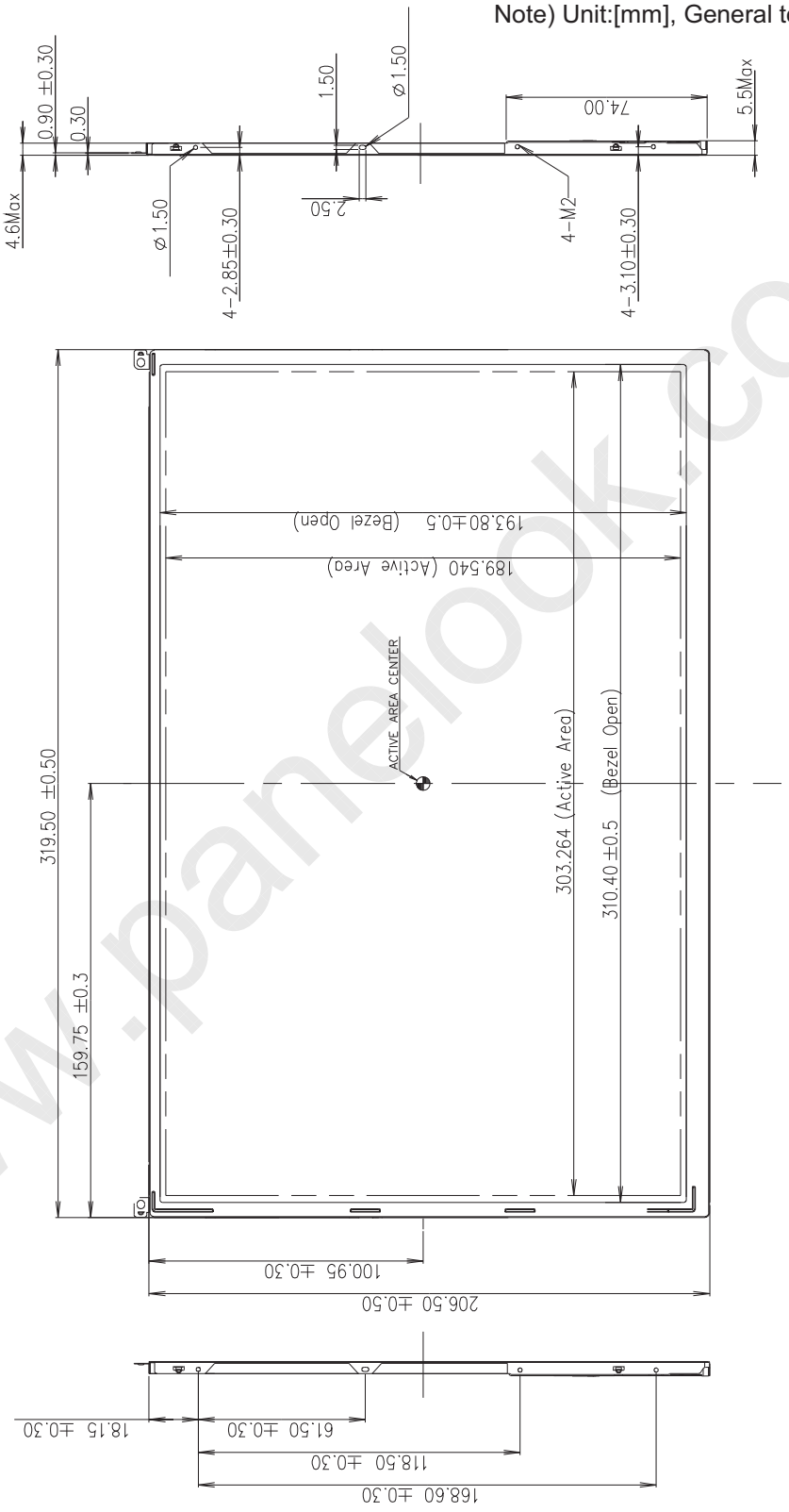
5. Mechanical Characteristics

The contents provide general mechanical characteristics for the model LP141WP2.
In addition the figures in the next page are detailed mechanical drawing of the LCD.

Outline Dimension	Horizontal	319.5 ± 0.50mm
	Vertical	206.5 ± 0.50mm
	Depth	5.5mm(Max.)
Bezel Area	Horizontal	310.4mm
	Vertical	193.8mm
Active Display Area	Horizontal	303.264mm
	Vertical	189.54 mm
Weight	375g (Max.)	
Surface Treatment	Anti Glare treatment of the front polarizer	

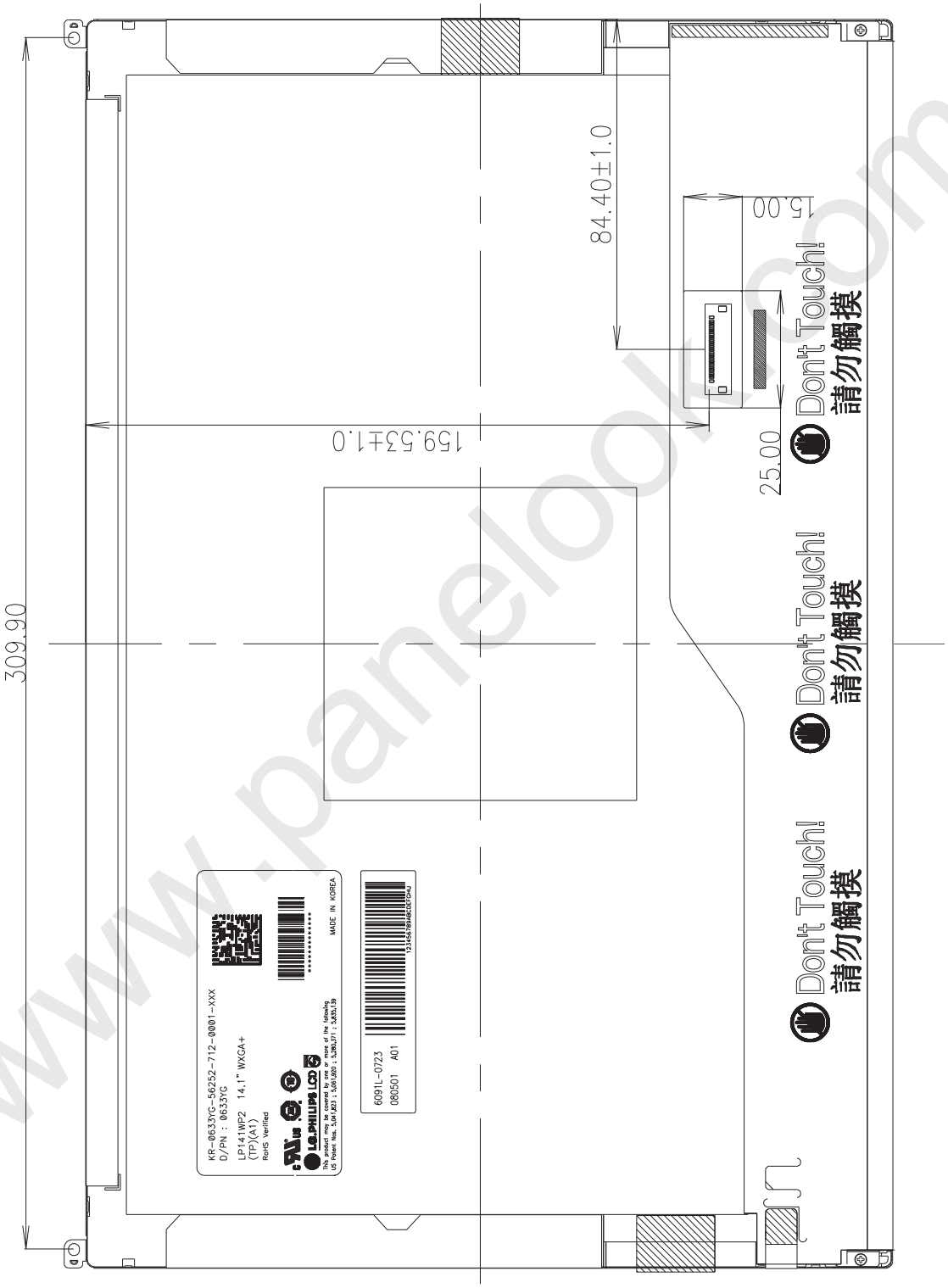
<FRONT VIEW>

Note) Unit:[mm], General tolerance: ± 0.5mm

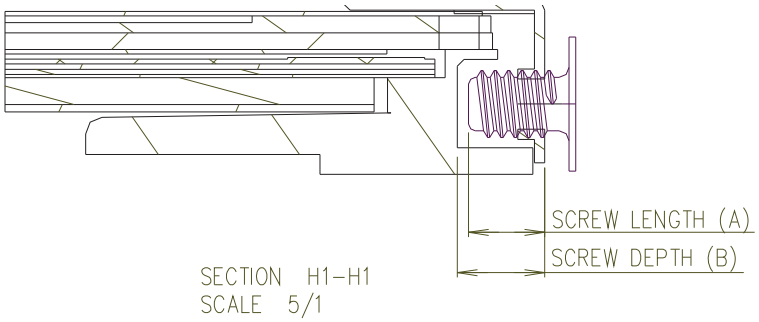


<REAR VIEW>

Note) Unit:[mm], General tolerance: ± 0.5mm



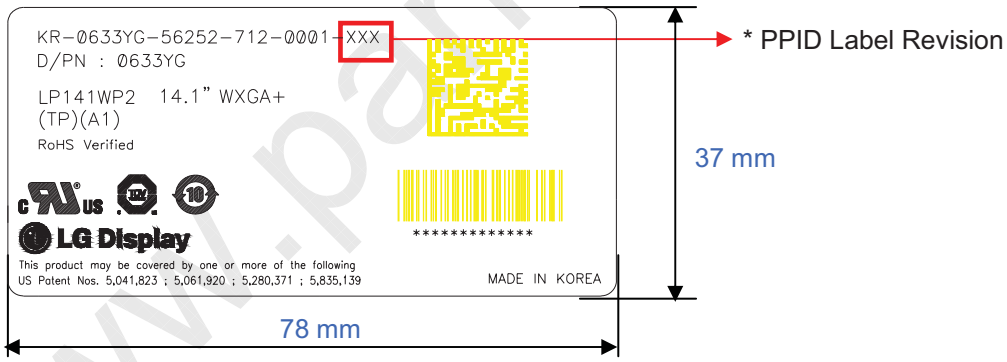
[DETAIL DESCRIPTION OF SIDE MOUNTING SCREW]



* Mounting Screw Length (A)
  = 2.0(Min) / 2.5(Max)
* Mounting Screw Hole Depth (B)
  = 2.5(Min)
* Mounting hole location : 3.7(typ.)
* Torque : 2.5 kgf.cm(Max)
  (Measurement gauge : torque meter)

Notes : 1. Screw plated through the method of non-electrolytic nickel plating is preferred to reduce possibility that results in vertical and/or horizontal line defect due to the conductive particles from screw surface.

[DETAIL INFORMATION OF PPID LABEL AND REVISION CODE]

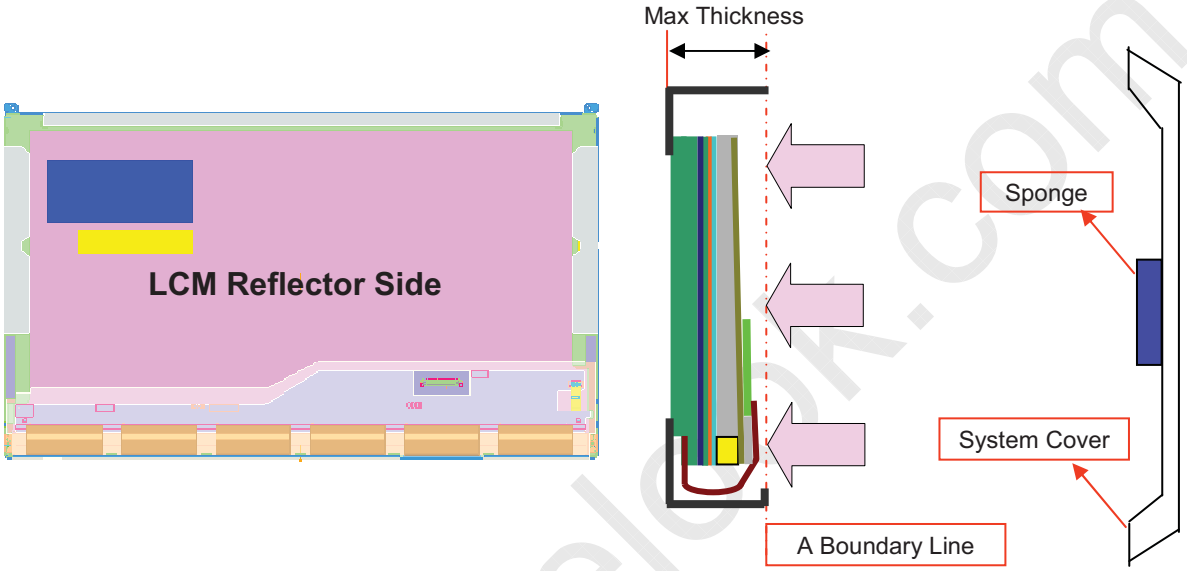


* PPID Label Revision :
  It is subject to change with Dell event. Please refer to the below table for detail.

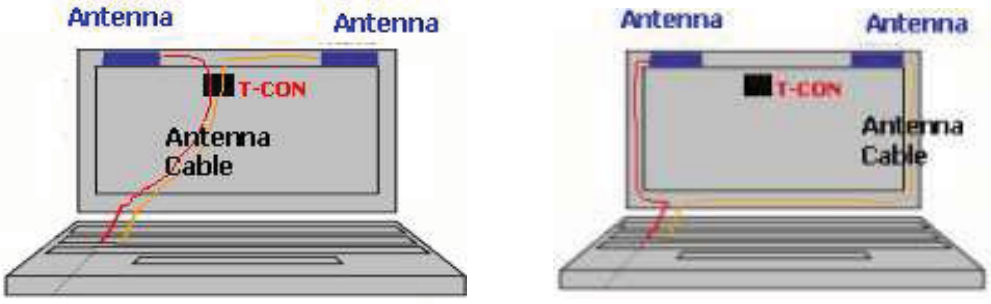
Classification	No Change	1st Revision	2nd Revision	…	9th Revision	…
SST(WS)	X00	X01	X02	…	A09	…
PT(ES)	X10	X11	X12	…	A19	…
ST(CS)	X20	X21	X22	…	A29	…
XB(MP)	A00	A01	A02	…	A09	…

LGD Proposal for system cover design.(Appendix)

1	Gap check for securing the enough gap between LCM and System cover.	



Notes	1.Rear side of LCM is sensitive against external stress,and previous check about interference is highly needed. 2.In case there is something from system cover comes into the boundary above,mechanical interference may cause the FOS defects. (Eg:Ripple,White spot..)
2	Check if antenna cable is sufficiently apart from T-CON of LCD Module.

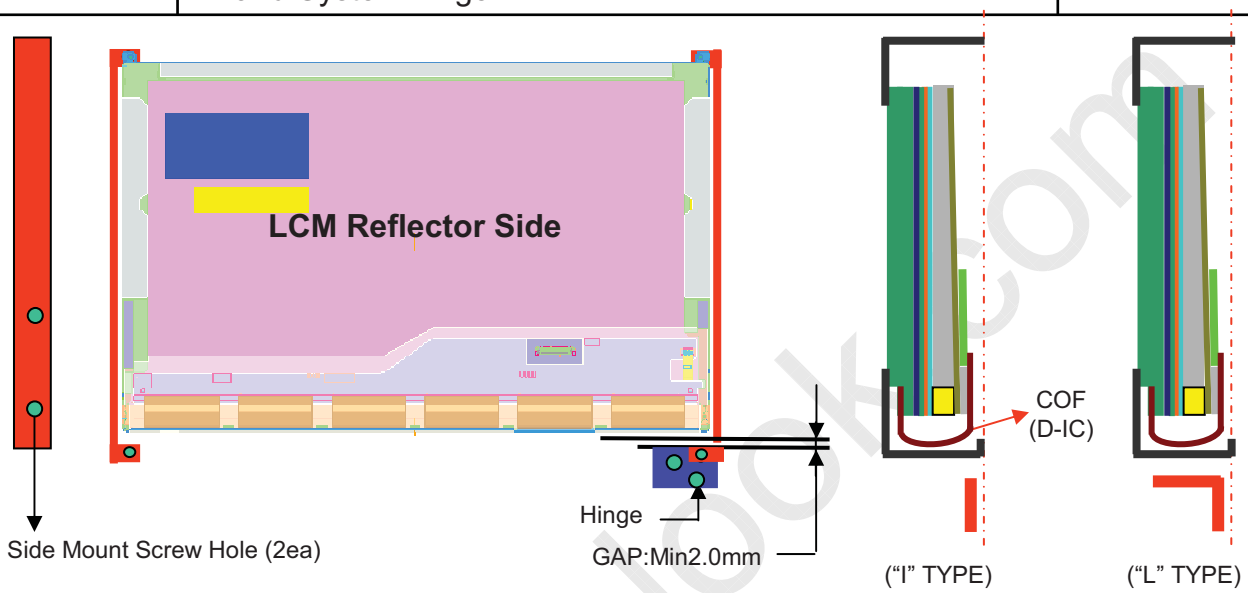


NO GOOD GOOD

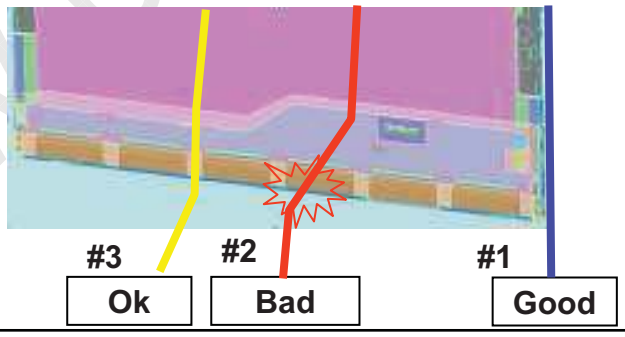
Notes	1.If system antenna is overlapped with T-CON,it might be cause the noise.

LGD Proposal for system cover design.

3	Gap check for securing enough gap between LCM and System hinge.	



Notes	1. At least 2.0mm gap is required to secure from any damage during shock test. 2. "L" type hinge is more recommended than "I" type to get better performance for shock test.
4	Checking the path of the System wire.

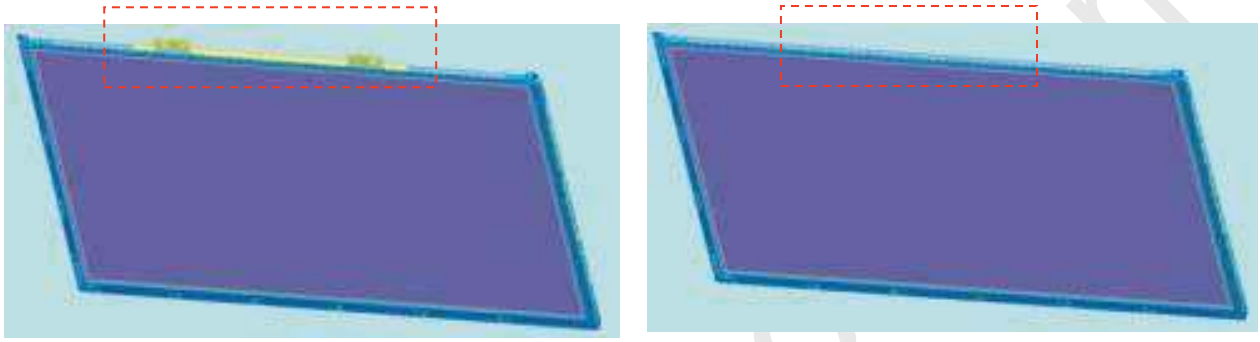


Notes	1. It is required to handle COF area carefully . 2. Good : Wire path does not overlap with LCM OK : Wire path is located between COFs. BAD : Wire path overlapped with COF area. Flat type cable is highly recommended if cable should be located on bad case

LGD Proposal for system cover design.

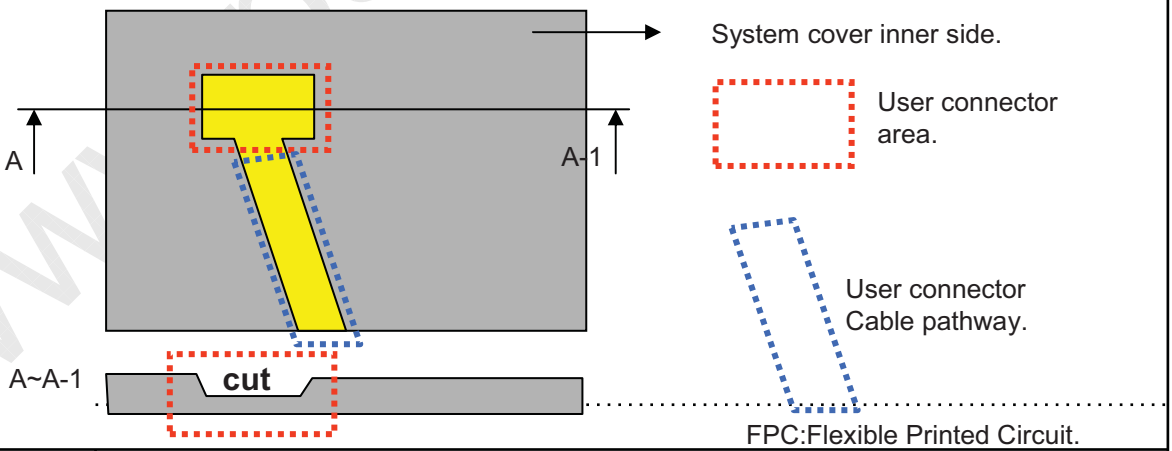
5	Using a bracket on the top of LCM is not recommended.	

bracket



With bracket Without bracket

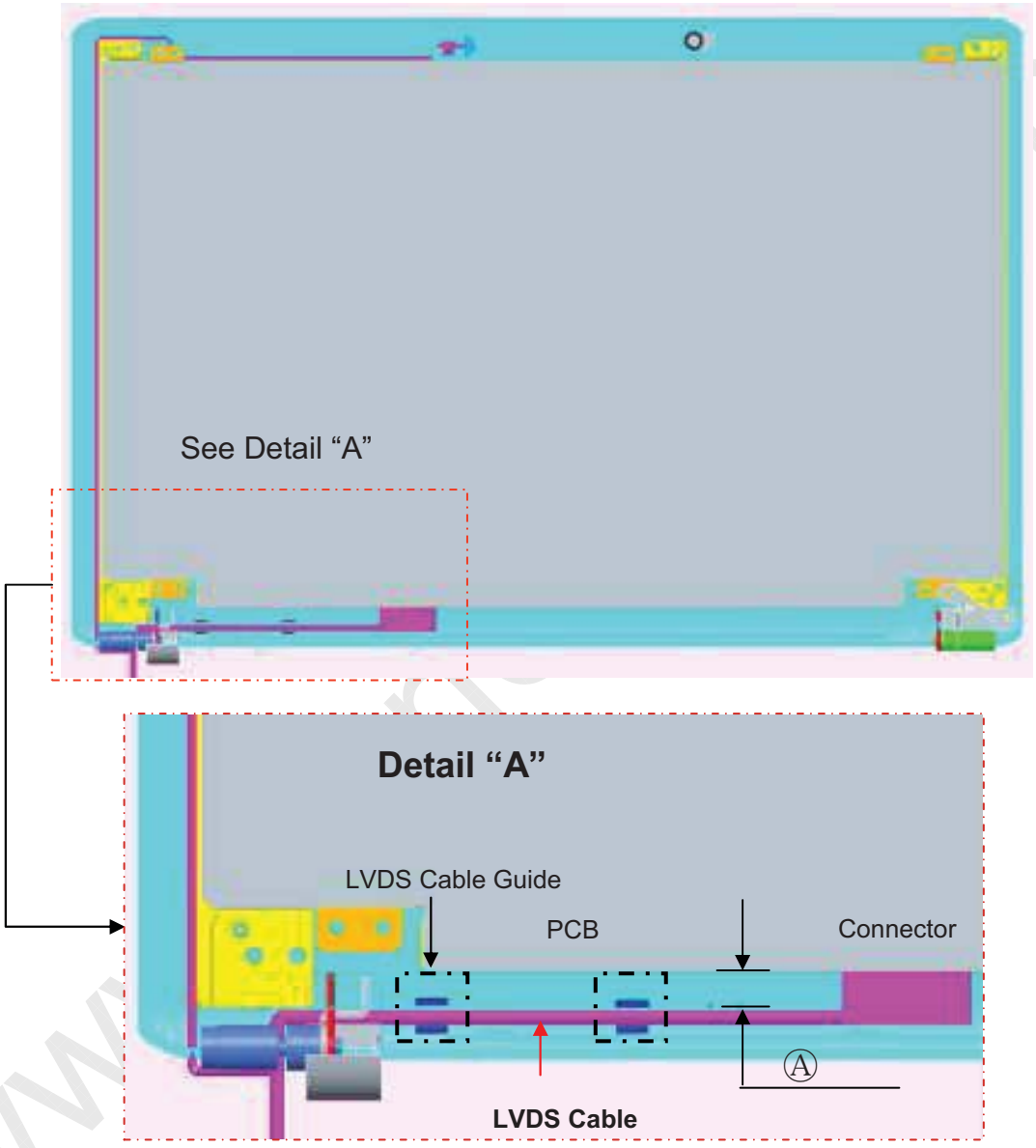
Notes	1.Condition without bracket is good for mechanical noise,and can minimize the light leakage from deformation of bracket. 2.The results shows that there is no difference between the condition with or without bracket.
6	Securing additional gap on CNT area..



Notes	1.CNT area is specially sensitive against external stress,and additional gap by cutting on system cover will be helpful on removing the Ripple. 2.Using a thinner CNT will be better. (eg: FPC type)

LGD Proposal for system cover design.

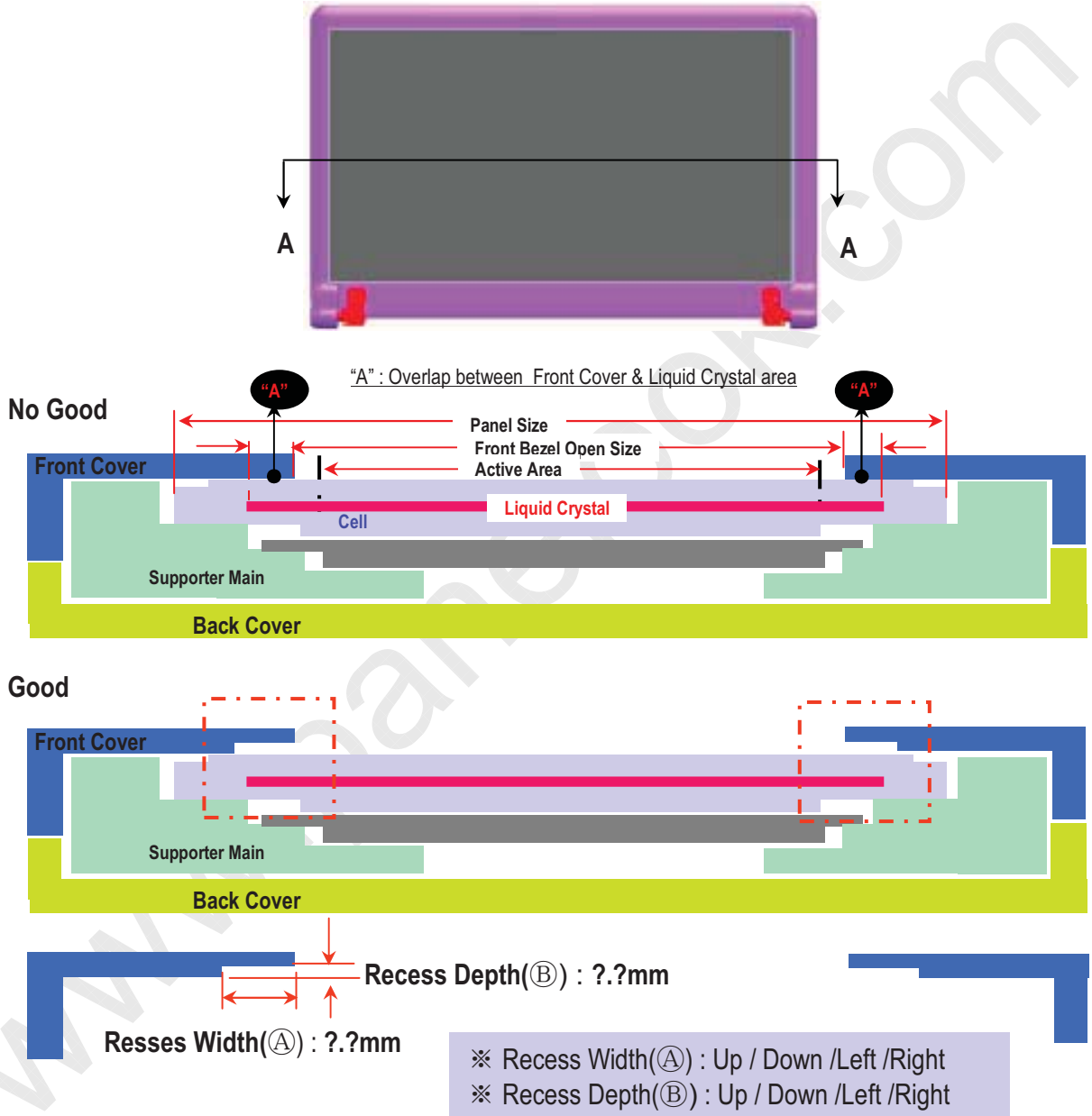
7	Checking the path of System LVDS Cable.



Notes	1. At least 1.0mm gap (Ⓐ) is required to secure from any damage by overlapping system cable and LCM (This overlap may cause a Abnormal Display after hinge test)
	2."Flat" type of LVDS cable is more recommended than "Cylinderical" type . 3. Making LVDS Cable Guide will give better performance . (Refer to detail "A")

LGD Proposal for system cover design.

8	Securing additional gap between front cover & LCD at edge of front cover.



Notes	1.Active area which is filled with Liquid Crystal is sensitive against external stress, so additional gap to make recess area on the edge of front cover will be helpful to prevent mechanical Ripple. (Dimension of Recess depends on each model design)

6. Reliability

Environment test condition

No.	Test Item	Conditions
1	High temperature storage test	Ta= 60°C, 240h
2	Low temperature storage test	Ta= -20°C, 240h
3	High temperature operation test	Ta= 50°C, 50%RH, 240h
4	Low temperature operation test	Ta= 0°C, 240h
5	Vibration test (non-operating)	Sine wave, 10 ~ 500 ~ 10Hz, 1.5G, 0.37oct/min 3 axis, 1hour/axis
6	Shock test (non-operating)	Half sine wave, 180G, 2ms one shock of each six faces(I.e. run 180G 2ms for all six faces)
7	Altitude operating storage / shipment	0 ~ 10,000 feet (3,048m) 24Hr 0 ~ 40,000 feet (12,192m) 24Hr

{ Result Evaluation Criteria }
There should be no change which might affect the practical display function when the display quality test is conducted under normal operating condition.

7. International Standards

7-1. Safety

a) UL 60950-1, Second Edition, Underwriters Laboratories Inc.
Information Technology Equipment - Safety - Part 1 : General Requirements.

b) CAN/CSA C22.2 No.60950-1-07, Second Edition, Canadian Standards Association.
Information Technology Equipment - Safety - Part 1 : General Requirements.

c) EN 60950-1:2006 + A11:2009, European Committee for Electro-technical Standardization (CENELEC).
Information Technology Equipment - Safety - Part 1 : General Requirements.

d) IEC 60950-1:2005, Second Edition, The International Electro-technical Commission (IEC).
Information Technology Equipment - Safety - Part 1 : General Requirements.

7-2. EMC

a) ANSI C63.4 "American National Standard for Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electronic Equipment in the Range of 9 kHz to 40 GHz." American National Standards Institute (ANSI), 2003.

b) CISPR 22 "Information technology equipment – Radio disturbance characteristics – Limit and methods of measurement." International Special Committee on Radio Interference (CISPR), 2005.

c) CISPR 13 "Sound and television broadcast receivers and associated equipment – Radio disturbance characteristics – Limits and method of measurement." International Special Committee on Radio Interference (CISPR), 2006.

7-3. Environment

a) RoHS, Directive 2002/95/EC of the European Parliament and of the council of 27 January 2003

8. Packing

8-1. Designation of Lot Mark

a) Lot Mark

A	B	C	D	E	F	G	H	I	J	K	L	M

A,B,C : SIZE(INCH)
D : YEAR
E : MONTH
F ~ M : SERIAL NO.

Note

1. YEAR

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010
Mark	1	2	3	4	5	6	7	8	9	0

2. MONTH

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Mark	1	2	3	4	5	6	7	8	9	A	B	C

b) Location of Lot Mark

Serial No. is printed on the label. The label is attached to the backside of the LCD module.
This is subject to change without prior notice.

8-2. Packing Form

a) Package quantity in one box : 30 pcs

b) Box Size : 490mm X 393mm X 287mm

9. PRECAUTIONS

Please pay attention to the followings when you use this TFT LCD module.

9-1. MOUNTING PRECAUTIONS

(1) You must mount a module using holes arranged in four corners or four sides.
(2) You should consider the mounting structure so that uneven force (ex. Twisted stress) is not applied to the module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
(3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
(4) You should adopt radiation structure to satisfy the temperature specification.
(5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit break by electro-chemical reaction.
(6) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment.
Do not touch the surface of polarizer for bare hand or greasy cloth.(Some cosmetics are detrimental to the polarizer.)
(7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front / rear polarizers. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
(8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
(9) Do not open the case because inside circuits do not have sufficient strength.

9-2. OPERATING PRECAUTIONS

(1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage :
V=± 200mV(Over and under shoot voltage)

(2) Response time depends on the temperature.(In lower temperature, it becomes longer.)
(3) Brightness depends on the temperature. (In lower temperature, it becomes lower.)
And in lower temperature, response time(required time that brightness is stable after turned on) becomes longer.
(4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
(5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
(6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimized the interference.

9-3. ELECTROSTATIC DISCHARGE CONTROL

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't touch interface pin directly.

9-4. PRECAUTIONS FOR STRONG LIGHT EXPOSURE

Strong light exposure causes degradation of polarizer and color filter.

9-5. STORAGE

When storing modules as spares for a long time, the following precautions are necessary.

(1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
(2) The polarizer surface should not come in contact with any other object.
It is recommended that they be stored in the container in which they were shipped.

9-6. HANDLING PRECAUTIONS FOR PROTECTION FILM

(1) When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
(2) The protection film is attached to the polarizer with a small amount of glue. If some stress is applied to rub the protection film against the polarizer during the time you peel off the film, the glue is apt to remain on the polarizer.
Please carefully peel off the protection film without rubbing it against the polarizer.
(3) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the polarizer after the protection film is peeled off.
(4) You can remove the glue easily. When the glue remains on the polarizer surface or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.

APPENDIX A. Enhanced Extended Display Identification Data (EEDID™) 1/3

EDID Data for *Dell* ver. 1.0 (Final Sample)

2010. 03. 05

	Byte (Dec)	Byte (Hex)	Field Name and Comments	Value (Hex)	Value (Bin)
Header	0	00	Header	00	00000000
	1	01	Header	FF	11111111
	2	02	Header	FF	11111111
	3	03	Header	FF	11111111
	4	04	Header	FF	11111111
	5	05	Header	FF	11111111
	6	06	Header	FF	11111111
	7	07	Header	00	00000000
Vendor / Product	8	08	ID Manufacture Name LGD	30	00110000
	9	09	ID Manufacture Name	E4	11100100
	10	0A	ID Product Code 0257h	57	01010111
	11	0B	(Hex. LSB first)	02	00000010
	12	0C	ID Serial No. - Optional ("00h" If not used, Number Only and LSB First)	00	00000000
	13	0D	ID Serial No. - Optional ("00h" If not used, Number Only and LSB First)	00	00000000
	14	0E	ID Serial No. - Optional ("00h" If not used, Number Only and LSB First)	00	00000000
	15	0F	ID Serial No. - Optional ("00h" If not used, Number Only and LSB First)	00	00000000
	16	10	Week of Manufacture - Optinal 00 weeks	00	00000000
	17	11	Year of Manufacture 2009 years	13	00010011
	18	12	EDID structure version # = 1	01	00000001
	19	13	EDID revision # = 4	04	00000100
Display	20	14	Video Input Definition = Input is a Digital Video signal interface ; Color Bit Depth : 6 Bits per Primary Color ; Digital Video Interface Standard Supported: DisplayPort is supported	95	10010101
	21	15	Horizontal Screen Size (Rounded cm) = 30 cm	1E	00011110
	22	16	Vertical Screen Size (Rounded cm) = 19 cm	13	00010011
	23	17	Display Transfer Characteristic (Gamma) = (gamma*100)-100 = Example:(2.2*100)-100=120 = 2.2 Gam	78	01111000
	24	18	Feature Support [Display Power Management(DPM) : Standby Mode is not supported, Suspend Mode is not supported, Active Off = Very Low Power is not supported ,Supportted Color Encoding Formats : RGB 4:4:4 ,Other Feature Support Flags : No_sRGB, Preferred Timing Mode, No_Display is continuous frequency (Multi-mode Base EDID and Extension Block).]	02	00000010
Vendor / Product	25	19	Red/Green Low Bits (RxRy/GxGy)	D7	11010111
	26	1A	Blue/White Low Bits (BxBy/WxWy)	85	10000101
	27	1B	Red X Rx = 0.577	93	10010011
	28	1C	Red Y Ry = 0.349	59	01011001
	29	1D	Green X Gx = 0.329	54	01010100
	30	1E	Green Y Gy = 0.550	8C	10001100
	31	1F	Blue X Bx = 0.162	29	00101001
	32	20	Blue Y By = 0.133	22	00100010
	33	21	White X Wx = 0.313	50	01010000
	34	22	White Y Wy = 0.329	54	01010100
Established	35	23	Established timing 1 (Optional_00h if not used)	00	00000000
	36	24	Established timing 2 (Optional_00h if not used)	00	00000000
	37	25	Manufacturer's timings (Optional_00h if not used)	00	00000000
Standard Timing ID	38	26	Standard timing ID1 (Optional_01h if not used)	01	00000001
	39	27	Standard timing ID1 (Optional_01h if not used)	01	00000001
	40	28	Standard timing ID2 (Optional_01h if not used)	01	00000001
	41	29	Standard timing ID2 (Optional_01h if not used)	01	00000001
	42	2A	Standard timing ID3 (Optional_01h if not used)	01	00000001
	43	2B	Standard timing ID3 (Optional_01h if not used)	01	00000001
	44	2C	Standard timing ID4 (Optional_01h if not used)	01	00000001
	45	2D	Standard timing ID4 (Optional_01h if not used)	01	00000001
	46	2E	Standard timing ID5 (Optional_01h if not used)	01	00000001
	47	2F	Standard timing ID5 (Optional_01h if not used)	01	00000001
	48	30	Standard timing ID6 (Optional_01h if not used)	01	00000001
	49	31	Standard timing ID6 (Optional_01h if not used)	01	00000001
	50	32	Standard timing ID7 (Optional_01h if not used)	01	00000001
	51	33	Standard timing ID7 (Optional_01h if not used)	01	00000001
	52	34	Standard timing ID8 (Optional_01h if not used)	01	00000001
	53	35	Standard timing ID8 (Optional_01h if not used)	01	00000001

APPENDIX A. Enhanced Extended Display Identification Data (EEDID™) 2/3

	Byte (Dec)	Byte (Hex)	Field Name and Comments	Value (Hex)	Value (Bin)
Timing Descriptor #1	54	36	Pixel Clock/10,000 (LSB) 85.4 MHz @ 60Hz	5C	01011100
	55	37	Pixel Clock/10,000 (MSB)	21	00100001
	56	38	Horizontal Active (HA) (lower 8 bits) 1440 Pixels	A0	10100000
	57	39	Horizontal Blanking (HB) (lower 8 bits) 112 Pixels	70	01110000
	58	3A	Horizontal Active / Horizontal Blanking(HA HB) (upper 4:4bits)	50	01010000
	59	3B	Vertical Avtive (VA) 900 Lines	84	10000100
	60	3C	Vertical Blanking (VB) (DE Blanking typ.for DE only panels) 17 Lines	11	00010001
	61	3D	Vertical Active / Vertical Blanking (VA VB) (upper 4:4bits)	30	00110000
	62	3E	Horizontal Front Porch in pixels (HF) (lower 8 bits)32 Pixels	20	00100000
	63	3F	Horizontal Sync Pulse Width in pixels (HS) (lower 8 bits) 32 Pixels	20	00100000
	64	40	Vertical Front Porch in lines (VF) (lower 4 bits) : Vertical Sync Pluse Width in lines (VS) (lower 4 bits)	36	00110110
	65	41	Horizontal Front Porch/ Sync Pulse Width/ Vertical Front Porch/ Sync Pulse Width (upper 2bits)	00	00000000
	66	42	Horizontal Vedio Image Size (mm) (lower 8 bits) 304 mm	30	00110000
	67	43	Vertical Vedio Image Size (mm) (lower 8 bits) 190 mm	BE	10111110
	68	44	Horizontal Image Size / Vertical Image Size (upper 4 bits)	10	00010000
	69	45	Horizontal Border = 0 (Zero for Notebook LCD)	00	00000000
	70	46	Vertical Border = 0 (Zero for Notebook LCD)	00	00000000
	71	47	Non-Interlace, Normal display, no stereo, Digital Separate [Vsync_NEG, Hsync_POS (outside of V-sync)]	1A	00011010
Timing Descriptor #2	72	48	Pixel Clock/10,000 (LSB) 60 MHz @ 40Hz	70	01110000
	73	49	Pixel Clock/10,000 (MSB)	17	00010111
	74	4A	Horizontal Active (HA) (lower 8 bits) 1440 Pixels	A0	10100000
	75	4B	Horizontal Blanking (HB) (lower 8 bits) 192 Pixels	C0	11000000
	76	4C	Horizontal Active / Horizontal Blanking(HA HB) (upper 4:4bits)	50	01010000
	77	4D	Vertical Avtive (VA) 900 Lines	84	10000100
	78	4E	Vertical Blanking (VB) (DE Blanking typ.for DE only panels) 20 Lines	14	00010100
	79	4F	Vertical Active / Vertical Blanking (VA VB) (upper 4:4bits)	30	00110000
	80	50	Horizontal Front Porch in pixels (HF) (lower 8 bits)48 Pixels	30	00110000
	81	51	Horizontal Sync Pulse Width in pixels (HS) (lower 8 bits) 32 Pixels	20	00100000
	82	52	Vertical Front Porch in lines (VF) (lower 4 bits) : Vertical Sync Pluse Width in lines (VS) (lower 4 bits)	36	00110110
	83	53	Horizontal Front Porch/ Sync Pulse Width/ Vertical Front Porch/ Sync Pulse Width (upper 2bits)	00	00000000
	84	54	Horizontal Vedio Image Size (mm) (lower 8 bits) 304 mm	30	00110000
	85	55	Vertical Vedio Image Size (mm) (lower 8 bits) 190 mm	BE	10111110
	86	56	Horizontal Image Size / Vertical Image Size (upper 4 bits)	10	00010000
	87	57	Horizontal Border = 0 (Zero for Notebook LCD)	00	00000000
	88	58	Vertical Border = 0 (Zero for Notebook LCD)	00	00000000
	89	59	Non-Interlace, Normal display, no stereo, Digital Separate [Vsync_NEG, Hsync_POS (outside of V-sync)]	1A	00011010
Timing Descriptor #3	90	5A	Flag	00	00000000
	91	5B	Flag	00	00000000
	92	5C	Flag	00	00000000
	93	5D	Data Type Tag : Alphanumeric Data String (ASCII String)	FE	11111110
	94	5E	Flag	00	00000000
	95	5F	Dell P/N 1st Character = 6	36	.00110110
	96	60	Dell P/N 2nd Character = 3	33	00110011
	97	61	Dell P/N 3rd Character = 3	33	00110011
	98	62	Dell P/N 4th Character = Y	59	01011001
	99	63	Dell P/N 5th Character = G	47	01000111
	100	64	EDID Revision Build Name = XB (MP) , Revision # = A00	80	10000000
	101	65	Manufacturer P/N = 1	31	00110001
	102	66	Manufacturer P/N = 4	34	00110100
	103	67	Manufacturer P/N = 1	31	00110001
	104	68	Manufacturer P/N = W	57	01010111
	105	69	Manufacturer P/N = P	50	01010000
	106	6A	Manufacturer P/N = 2	32	00110010
	107	6B	Manufacturer P/N (If < 13 char, then terminate with ASCⅡ code 0Ah,set remaining char = 20h)	0A	00001010

APPENDIX A. Enhanced Extended Display Identification Data (EEDID™) 3/3

	Byte (Dec)	Byte (Hex)	Field Name and Comments	Value (Hex)	Value (Bin)
Timing Descriptor #4	108	6C	Flag	00	00000000
	109	6D	Flag	00	00000000
	110	6E	Flag	00	00000000
	111	6F	Data Type Tag : Descriptor Defined by manufacturer	00	00000000
	112	70	Flag	00	00000000
	113	71	Color Management [No +2 FRC Support, True Color Depth : 6 bit]	00	00000000
	114	72	Panel Type [WLED] , Configuration [Single light bar], Number Lamp or LED Light Bar [one]	41	01000001
	115	73	Frame Rate Details [Minimum Frame Rate : 40Hz, Maximum Frame Rate : 65Hz , Tcon provides native Intel DRRS / sDRRS support]	31	00110001
	116	74	Controller Interface and Maximum Luminance [SMBUS type, 330 nit]	21	00100001
	117	75	Front Surface / Polarizer [Anti-Glare, No Transflective] , Pixel Structure [RGB v-stripe]	00	00000000
	118	76	Multi-Media Features [Color Management : NTSC, Dynamic Backlight Control : No]	00	00000000
	119	77	Multi-Media Features [Motion Blur : No support , Active Gamma Control : No support]	00	00000000
	120	78	Special Features [Wireless Enhancement Hardware : No support , In-Cell Scanner : No support]	00	00000000
	121	79	Special Features [Number of LVDS channels or eDP lanes : one , Overdrive : No ,Interface : eDP , In-Cell Touch Support : No]	09	00001001
	122	7A	Special Features [BIST Support : yes , Electronic Privacy : No electronic privacy hardware support , 3-D Support : No]	01	00000001
	123	7B	(If<13 char--> 0Ah, then terminate with ASCⅡ code 0Ah,set remaining char = 20h)	0A	00001010
	124	7C	(If<13 char--> 0Ah, then terminate with ASCⅡ code 0Ah,set remaining char = 20h)	20	00100000
	125	7D	(If<13 char--> 0Ah, then terminate with ASCⅡ code 0Ah,set remaining char = 20h)	20	00100000
Checksum	126	7E	Extension flag (# of optional 128 panel ID extension block to follow, Typ = 0)	00	00000000
	127	7F	Check Sum (The 1-byte sum of all 128 bytes in this panel ID block shall = 0)	33	00110011